

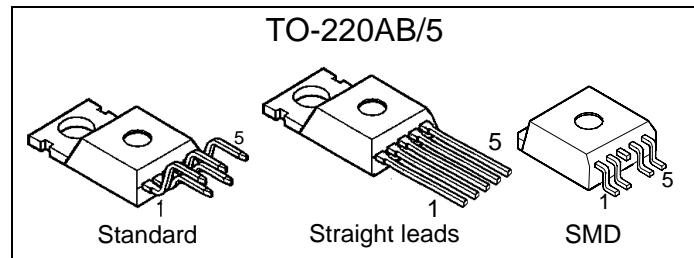
## Smart Highside Power Switch

### Features

- Overload protection
- Current limitation
- Short-circuit protection
- Thermal shutdown
- Ovvoltage protection (including load dump)
- Fast demagnetization of inductive loads
- Reverse battery protection<sup>1)</sup>
- Undervoltage and ovvoltage shutdown with auto-restart and hysteresis
- Open drain diagnostic output
- Open load detection in ON-state
- CMOS compatible input
- Loss of ground and loss of  $V_{bb}$  protection<sup>2)</sup>
- Electrostatic discharge (ESD) protection

### Product Summary

Ovvoltage protection	$V_{bb(AZ)}$	63	V
Operating voltage	$V_{bb(on)}$	4.5 ... 42	V
On-state resistance	$R_{ON}$	18	$m\Omega$
Load current (ISO)	$I_L(ISO)$	21	A
Current limitation	$I_L(SCr)$	70	A

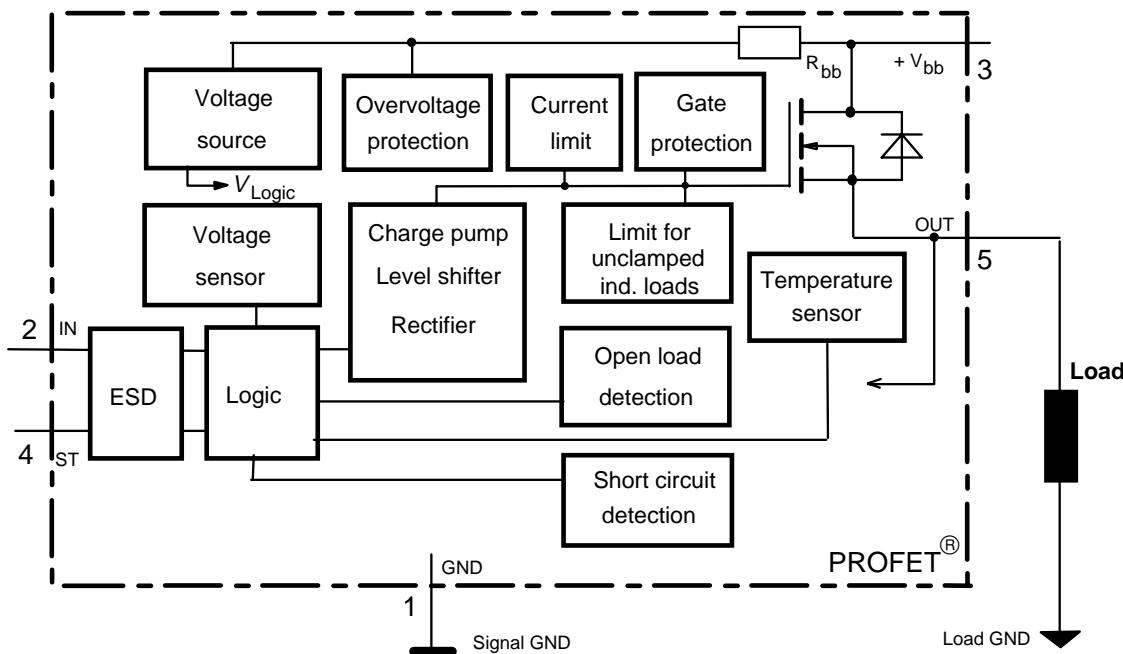


### Application

- $\mu$ C compatible power switch with diagnostic feedback for 12 V and 24 V DC grounded loads
- All types of resistive, inductive and capacitive loads
- Replaces electromechanical relays and discrete circuits

### General Description

N channel vertical power FET with charge pump, ground referenced CMOS compatible input and diagnostic feedback, integrated in Smart SIPMOS® chip on chip technology. Fully protected by embedded protection functions.



<sup>1)</sup> No external components required, reverse load current limited by connected load.

<sup>2)</sup> Additional external diode required for charged inductive loads

Pin	Symbol	Function
1	GND	- Logic ground
2	IN	I Input, activates the power switch in case of logical high signal
3	Vbb	+ Positive power supply voltage, the tab is shorted to this pin
4	ST	S Diagnostic feedback, low on failure
5	OUT (Load, L)	O Output to the load

**Maximum Ratings** at  $T_j = 25 \text{ }^\circ\text{C}$  unless otherwise specified

Parameter	Symbol	Values	Unit
Supply voltage (overvoltage protection see page 3)	$V_{bb}$	63	V
Load dump protection $V_{Load\ Dump} = U_A + V_s$ , $U_A = 13.5 \text{ V}$ $R_I = 2 \Omega$ , $R_L = 1.1 \Omega$ , $t_d = 200 \text{ ms}$ , IN= low or high	$V_{Load\ dump}^3)$	80	V
Load current (Short-circuit current, see page 4)	$I_L$	self-limited	A
Operating temperature range	$T_j$	-40 ...+150	$^\circ\text{C}$
Storage temperature range	$T_{stg}$	-55 ...+150	
Power dissipation (DC)	$P_{tot}$	167	W
Inductive load switch-off energy dissipation, single pulse	$E_{AS}$	2.1	J
Electrostatic discharge capability (ESD) (Human Body Model)	$V_{ESD}$	2.0	kV
Input voltage (DC)	$V_{IN}$	-0.5 ... +6	V
Current through input pin (DC)	$I_{IN}$	$\pm 5.0$	mA
Current through status pin (DC)	$I_{ST}$	$\pm 5.0$	
see internal circuit diagrams page 6...			
Thermal resistance chip - case: junction - ambient (free air): SMD version, device on pcb <sup>4)</sup> :	$R_{thJC}$ $R_{thJA}$	$\leq 0.75$ $\leq 75$ $\leq tbd$	K/W

<sup>3)</sup>  $V_{Load\ dump}$  is setup without the DUT connected to the generator per ISO 7637-1 and DIN 40839

<sup>4)</sup> Device on 50mm\*50mm\*1.5mm epoxy PCB FR4 with 6cm<sup>2</sup> (one layer, 70μm thick) copper area for  $V_{bb}$  connection. PCB is vertical without blown air.

### Electrical Characteristics

Parameter and Conditions at $T_j = 25^\circ\text{C}$ , $V_{bb} = 12\text{ V}$ unless otherwise specified	Symbol	Values			Unit
		min	typ	max	

### Load Switching Capabilities and Characteristics

On-state resistance (pin 3 to 5)					
$I_L = 5\text{ A}$	$T_j = 25^\circ\text{C}$ :	$R_{ON}$	--	15	18
	$T_j = 150^\circ\text{C}$ :			28	35
Nominal load current (pin 3 to 5) ISO Proposal: $V_{ON} = 0.5\text{ V}$ , $T_C = 85^\circ\text{C}$	$I_{L(\text{ISO})}$	17	21	--	A
Output current (pin 5) while GND disconnected or GND pulled up, $V_{IN} = 0$ , see diagram page 7, $T_j = -40...+150^\circ\text{C}$	$I_{L(\text{GNDhigh})}$	--	--	1	mA
Turn-on time	to 90% $V_{OUT}$ :	$t_{on}$	100	--	350
Turn-off time	to 10% $V_{OUT}$ :	$t_{off}$	10	--	130
$R_L = 12\Omega$ , $T_j = -40...+150^\circ\text{C}$					
Slew rate on 10 to 30% $V_{OUT}$ , $R_L = 12\Omega$ , $T_j = -40...+150^\circ\text{C}$	$dV/dt_{on}$	0.2	--	2	V/ $\mu\text{s}$
Slew rate off 70 to 40% $V_{OUT}$ , $R_L = 12\Omega$ , $T_j = -40...+150^\circ\text{C}$	$-dV/dt_{off}$	0.4	--	5	V/ $\mu\text{s}$

### Operating Parameters

Operating voltage <sup>5)</sup>	$T_j = -40...+150^\circ\text{C}$ :	$V_{bb(\text{on})}$	4.5	--	42	V
Undervoltage shutdown	$T_j = -40...+150^\circ\text{C}$ :	$V_{bb(\text{under})}$	2.4	--	4.5	V
Undervoltage restart	$T_j = -40...+150^\circ\text{C}$ :	$V_{bb(u\ rst)}$	--	--	4.5	V
Undervoltage restart of charge pump see diagram page 12	$T_j = -40...+150^\circ\text{C}$ :	$V_{bb(\text{ucp})}$	--	6.5	7.5	V
Undervoltage hysteresis $\Delta V_{bb(\text{under})} = V_{bb(u\ rst)} - V_{bb(\text{under})}$		$\Delta V_{bb(\text{under})}$	--	0.2	--	V
Oversupply shutdown	$T_j = -40...+150^\circ\text{C}$ :	$V_{bb(\text{over})}$	42	--	52	V
Oversupply restart	$T_j = -40...+150^\circ\text{C}$ :	$V_{bb(o\ rst)}$	42	--	--	V
Oversupply hysteresis	$T_j = -40...+150^\circ\text{C}$ :	$\Delta V_{bb(\text{over})}$	--	0.2	--	V
Oversupply protection <sup>6)</sup>	$T_j = -40^\circ\text{C}$ :	$V_{bb(AZ)}$	60	--	--	V
$I_{bb} = 40\text{ mA}$	$T_j = 25...+150^\circ\text{C}$ :		63	67		
Standby current (pin 3)	$T_j = -40...+25^\circ\text{C}$ :	$I_{bb(\text{off})}$	--	12	25	$\mu\text{A}$
$V_{IN} = 0$	$T_j = 150^\circ\text{C}$ :		--	18	60	
Leakage output current (included in $I_{bb(\text{off})}$ ) $V_{IN} = 0$		$I_{L(\text{off})}$	--	6	--	$\mu\text{A}$
Operating current (Pin 1) <sup>7)</sup> , $V_{IN} = 5\text{ V}$		$I_{GND}$	--	1.1	--	mA

5) At supply voltage increase up to  $V_{bb} = 6.5\text{ V}$  typ without charge pump,  $V_{OUT} \approx V_{bb} - 2\text{ V}$

6) see also  $V_{ON(CL)}$  in table of protection functions and circuit diagram page 7. Measured without load.

7) Add  $I_{ST}$ , if  $I_{ST} > 0$ , add  $I_{IN}$ , if  $V_{IN} > 5.5\text{ V}$

Parameter and Conditions	Symbol	Values			Unit
		min	typ	max	
<b>Protection Functions</b>					
Initial peak short circuit current limit (pin 3 to 5) <sup>8)</sup> , ( max 400 µs if $V_{ON} > V_{ON(SC)}$ )	$I_L(SCp)$				
$T_j = -40^\circ\text{C}$ : $T_j = 25^\circ\text{C}$ : $T_j = +150^\circ\text{C}$ :		--	--	140	A
Repetitive short circuit current limit $T_j = T_{jt}$ (see timing diagrams, page 10)	$I_L(SCr)$	30	70	--	A
Short circuit shutdown delay after input pos. slope $V_{ON} > V_{ON(SC)}$ , $T_j = -40..+150^\circ\text{C}$ : min value valid only, if input "low" time exceeds 30 µs	$t_d(SC)$	80	--	400	µs
Output clamp (inductive load switch off) at $V_{OUT} = V_{bb} - V_{ON(CL)}$ , $I_L = 30 \text{ mA}$	$V_{ON(CL)}$	--	58	--	V
Short circuit shutdown detection voltage (pin 3 to 5)	$V_{ON(SC)}$	--	8.3	--	V
Thermal overload trip temperature	$T_{jt}$	150	--	--	°C
Thermal hysteresis	$\Delta T_{jt}$	--	10	--	K
Inductive load switch-off energy dissipation <sup>9)</sup> , $T_j \text{ Start} = 150^\circ\text{C}$ , single pulse	$E_{AS}$	--	--	2.1	J
	$E_{Load12}$			1.7	
	$E_{Load24}$			1.2	
Reverse battery (pin 3 to 1) <sup>10)</sup>	$-V_{bb}$	--	--	32	V
Integrated resistor in $V_{bb}$ line	$R_{bb}$	--	120	--	Ω

### Diagnostic Characteristics

Open load detection current (on-condition)	$T_j = -40^\circ\text{C}$ : $T_j = 25..150^\circ\text{C}$ :	$I_{L(OL)}$	2	--	1900	mA
---	--	-------------	---	----	------	----

8) Short circuit current limit for max. duration of  $t_d(SC)$  max=400 µs, prior to shutdown

9) While demagnetizing load inductance, dissipated energy in PROFET is  $E_{AS} = \int V_{ON(CL)} * i_L(t) dt$ , approx.  
 $E_{AS} = \frac{1}{2} * L * I_L^2 * \left( \frac{V_{ON(CL)}}{V_{ON(CL)} - V_{bb}} \right)$ , see diagram page 8

10) Reverse load current (through intrinsic drain-source diode) is normally limited by the connected load.  
 Reverse current  $I_{GND}$  of  $\approx 0.3 \text{ A}$  at  $V_{bb} = -32 \text{ V}$  through the logic heats up the device. Time allowed under these condition is dependent on the size of the heatsink. Reverse  $I_{GND}$  can be reduced by an additional external GND-resistor ( $150 \Omega$ ). Input and Status currents have to be limited (see max. ratings page 2 and circuit page 7).

Parameter and Conditions at $T_j = 25^\circ\text{C}$ , $V_{bb} = 12\text{ V}$ unless otherwise specified	Symbol	Values			Unit
		min	typ	max	
<b>Input and Status Feedback<sup>11)</sup></b>					
Input turn-on threshold voltage $T_j = -40 \dots +150^\circ\text{C}$ :	$V_{IN(T+)}$	1.5	--	2.4	V
Input turn-off threshold voltage $T_j = -40 \dots +150^\circ\text{C}$ :	$V_{IN(T-)}$	1.0	--	--	V
Input threshold hysteresis	$\Delta V_{IN(T)}$	--	0.5	--	V
Off state input current (pin 2), $V_{IN} = 0.4\text{ V}$	$I_{IN(off)}$	1	--	30	$\mu\text{A}$
On state input current (pin 2), $V_{IN} = 3.5\text{ V}$	$I_{IN(on)}$	10	25	50	$\mu\text{A}$
Status invalid after positive input slope (short circuit) $T_j = -40 \dots +150^\circ\text{C}$ :	$t_{d(ST SC)}$	80	200	400	$\mu\text{s}$
Status invalid after positive input slope (open load) $T_j = -40 \dots +150^\circ\text{C}$ :	$t_{d(ST)}$	350	--	1600	$\mu\text{s}$
Status output (open drain) Zener limit voltage $T_j = -40 \dots +150^\circ\text{C}$ , $I_{ST} = +1.6\text{ mA}$ : ST low voltage $T_j = -40 \dots +150^\circ\text{C}$ , $I_{ST} = +1.6\text{ mA}$ :	$V_{ST(\text{high})}$ $V_{ST(\text{low})}$	5.4 --	6.1 --	-- 0.4	V

<sup>11)</sup> If a ground resistor  $R_{GND}$  is used, add the voltage drop across this resistor.

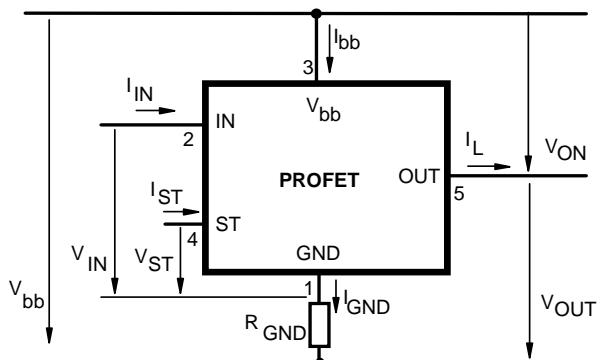
### Truth Table

	Input-level	Output level	Status	
			442 D2	442 E2
Normal operation	L	L	H	H
	H	H	H	H
Open load	L	<sup>12)</sup>	H	H
	H	H	L	L
Short circuit to GND	L	L	H	H
	H	L	L	L
Short circuit to V <sub>bb</sub>	L	H	H (L <sup>13)</sup> )	H (L <sup>13)</sup> )
	H	H		
Overtemperature	L	L	L	L
	H	L	L	L
Undervoltage	L	L	L <sup>14)</sup>	H
	H	L	L <sup>14)</sup>	H
Ovvervoltage	L	L	L	H
	H	L	L	H

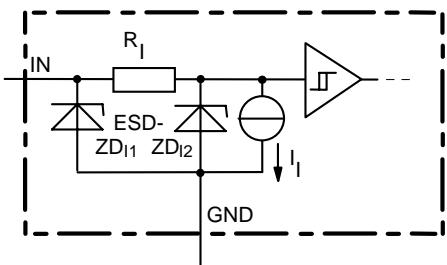
L = "Low" Level

H = "High" Level

### Terms

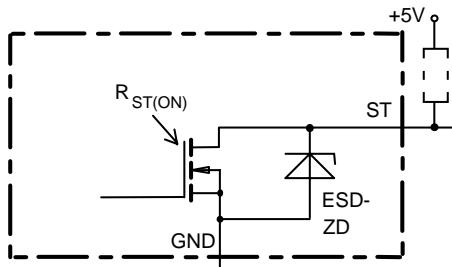


### Input circuit (ESD protection)



ZD<sub>11</sub> 6.1 V typ., ESD zener diodes are not to be used as voltage clamp at DC conditions. Operation in this mode may result in a drift of the zener voltage (increase of up to 1 V).

### Status output



ESD-Zener diode: 6.1 V typ., max 5 mA;  
 $R_{ST(ON)} < 250 \Omega$  at 1.6 mA, ESD zener diodes are not to be used as voltage clamp at DC conditions.  
 Operation in this mode may result in a drift of the zener voltage (increase of up to 1 V).

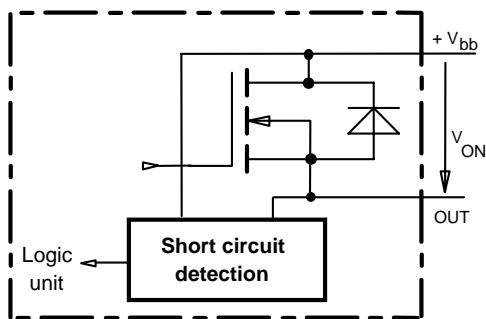
<sup>12)</sup> Power Transistor off, high impedance

<sup>13)</sup> Low resistance short V<sub>bb</sub> to output may be detected by no-load-detection

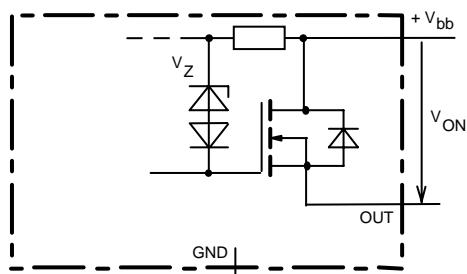
<sup>14)</sup> No current sink capability during undervoltage shutdown

### Short Circuit detection

Fault Condition:  $V_{ON} > 8.3 \text{ V typ.}$ ; IN high

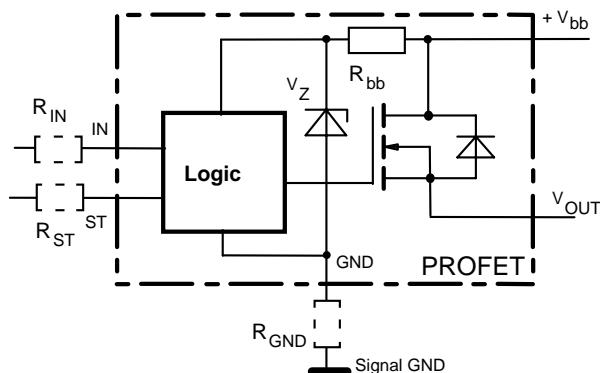


### Inductive and overvoltage output clamp



$V_{ON}$  clamped to 58 V typ.

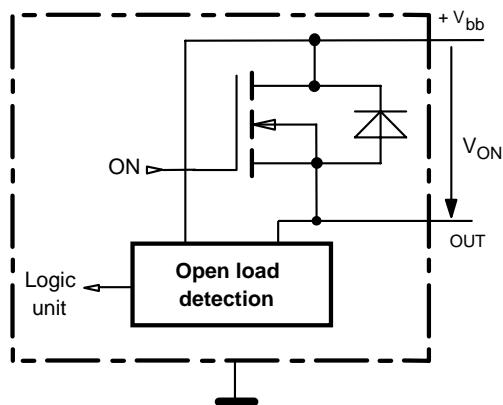
### Ovvolt. and reverse batt. protection



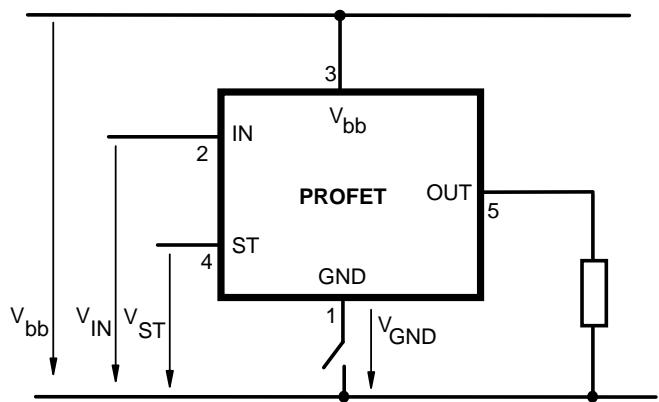
$R_{bb} = 120 \Omega \text{ typ.}$ ,  $V_Z + R_{bb} * 40 \text{ mA} = 67 \text{ V typ.}$ , add R<sub>GND</sub>, R<sub>IN</sub>, R<sub>ST</sub> for extended protection

### Open-load detection

ON-state diagnostic condition:  $V_{ON} < R_{ON} * I_{L(OL)}$ ; IN high

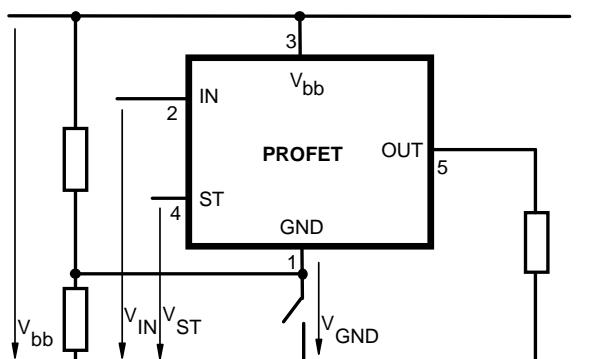


### GND disconnect



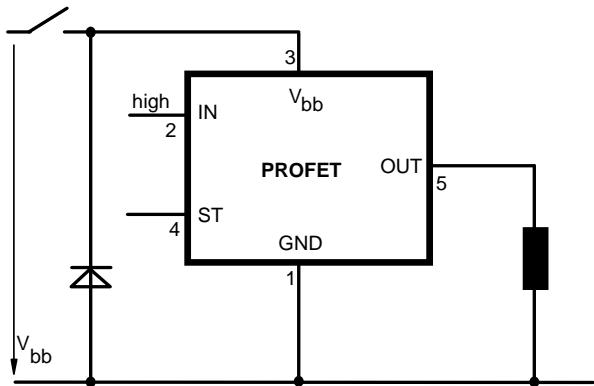
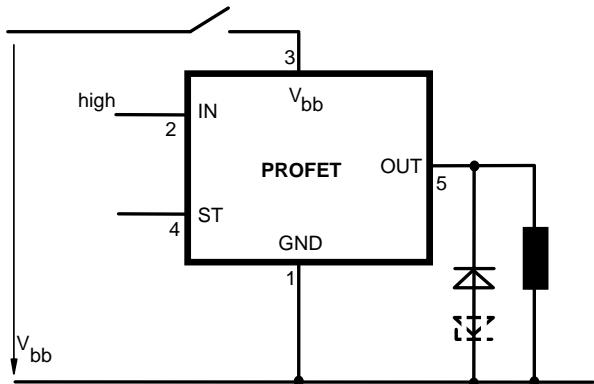
Any kind of load. In case of Input=high is  $V_{OUT} \approx V_{IN} - V_{IN(T+)}$ . Due to  $V_{GND} > 0$ , no  $V_{ST} = \text{low signal available}$ .

### GND disconnect with GND pull up

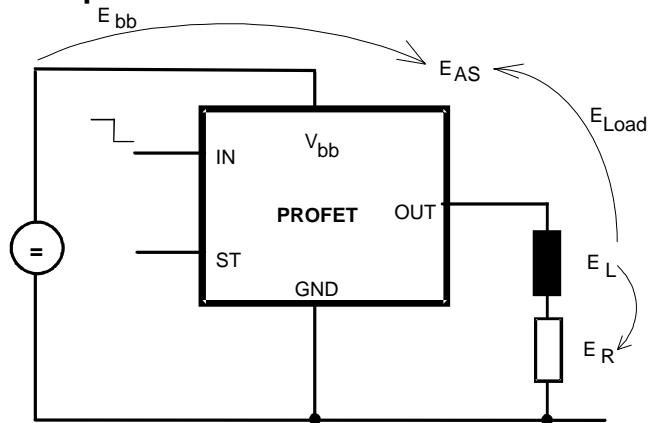


Any kind of load. If  $V_{GND} > V_{IN} - V_{IN(T+)}$  device stays off. Due to  $V_{GND} > 0$ , no  $V_{ST} = \text{low signal available}$ .

### V<sub>bb</sub> disconnect with charged inductive load



### Inductive Load switch-off energy dissipation



Energy dissipated in PROFET  $E_{AS} = E_{bb} + E_L - E_R$ .  
 $E_{Load} < E_L$ ,  $E_L = \frac{1}{2} * L * I_L^2$

**Options Overview**

**all versions: High-side switch, Input protection, ESD protection, load dump and reverse battery protection , protection against loss of ground**

Type	BTS	442D2	442E2
Logic version		D	E
Overtemperature protection $T_j > 150^\circ\text{C}$ , latch function <sup>15)16)</sup>	X		
$T_j > 150^\circ\text{C}$ , with auto-restart on cooling		X	
Short-circuit to GND protection switches off when $V_{ON} > 8.3 \text{ V typ.}$ <sup>15)</sup> (when first turned on after approx. 200 $\mu\text{s}$ )	X		X
Open load detection in OFF-state with sensing current 30 $\mu\text{A}$ typ. in ON-state with sensing voltage drop across power transistor	X		X
Undervoltage shutdown with auto restart	X		X
Ovvervoltage shutdown with auto restart	X		X
Status feedback for overttemperature short circuit to GND short to $V_{bb}$ open load undervoltage overvoltage	X X - X X X	X X - X -	
Status output type CMOS Open drain	X		X
Output negative voltage transient limit (fast inductive load switch off) to $V_{bb} - V_{ON(CL)}$		X	X
Load current limit high level (can handle loads with high inrush currents) medium level low level (better protection of application)	X		X

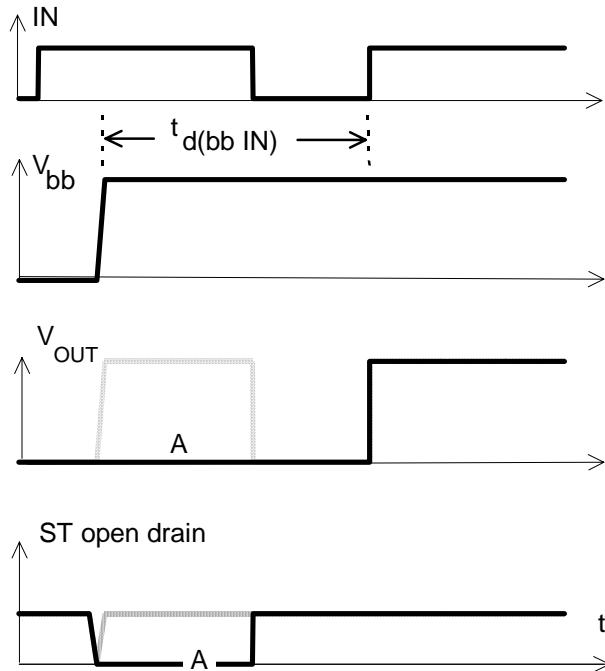
<sup>15)</sup> Latch except when  $V_{bb} - V_{OUT} < V_{ON(SC)}$  after shutdown. In most cases  $V_{OUT} = 0 \text{ V}$  after shutdown ( $V_{OUT} \neq 0 \text{ V}$  only if forced externally). So the device remains latched unless  $V_{bb} < V_{ON(SC)}$  (see page 4). No latch between turn on and  $t_d(SC)$ .

<sup>16)</sup> With latch function. Reseted by a) Input low, b) Undervoltage, c) Overvoltage

<sup>17)</sup> Low resistance short  $V_{bb}$  to output may be detected by no-load-detection

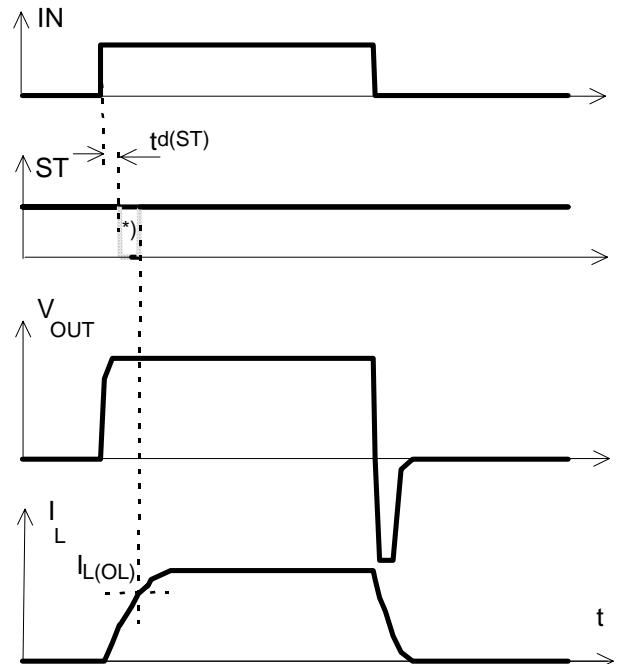
### Timing diagrams

**Figure 1a:**  $V_{bb}$  turn on:



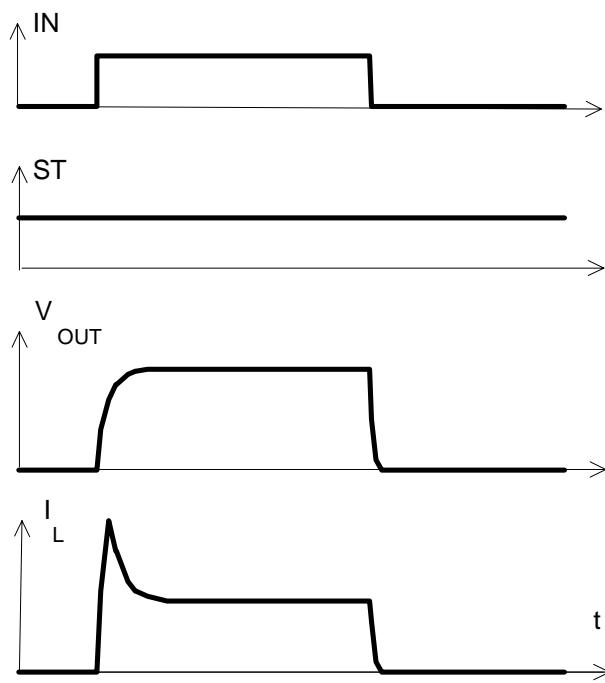
in case of too early  $V_{IN}$ =high the device may not turn on (curve A)  
 $t_d(bb\ IN)$  approx. 150  $\mu$ s

**Figure 2b:** Switching an inductive load

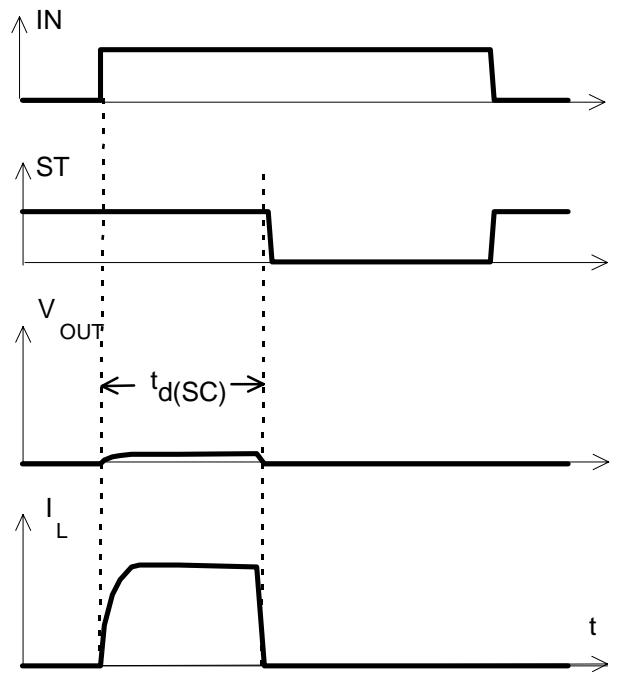


\*) if the time constant of load is too large, open-load-status may occur

**Figure 2a:** Switching a lamp,

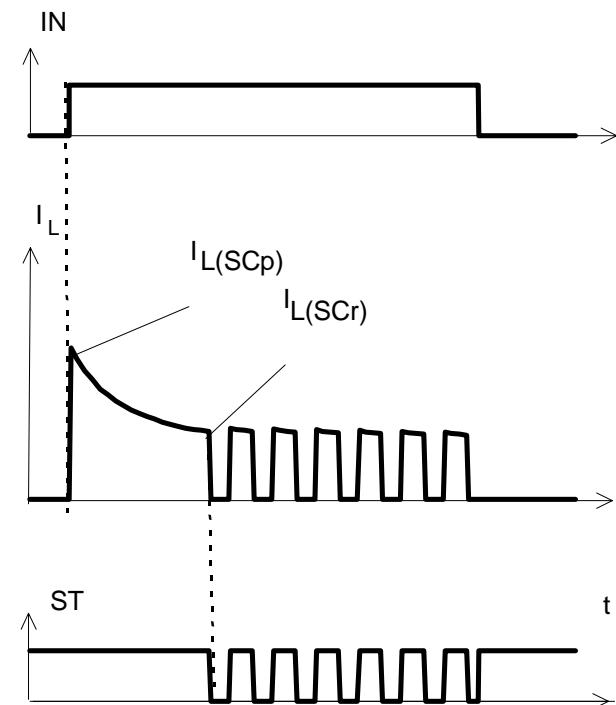


**Figure 3a:** Turn on into short circuit,



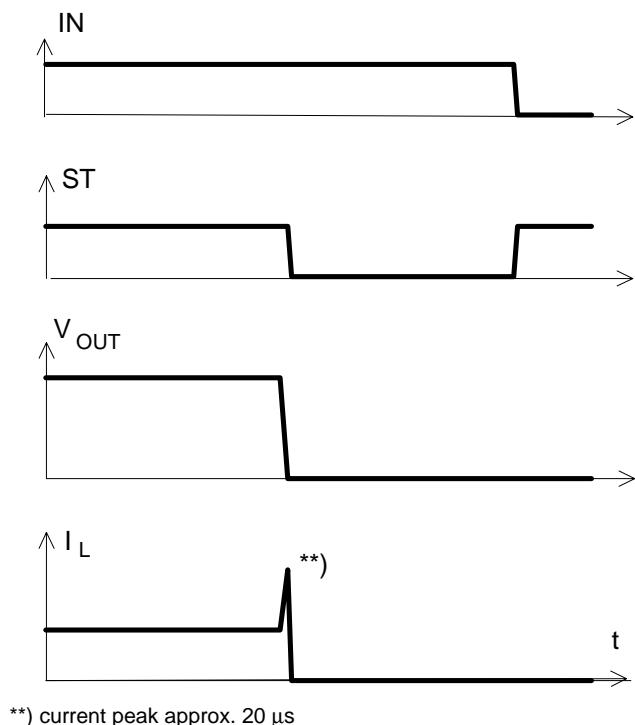
$t_d(SC)$  approx. 200  $\mu$ s if  $V_{bb} - V_{OUT} > 8.3$  V typ.

**Figure 3b:** Turn on into overload,



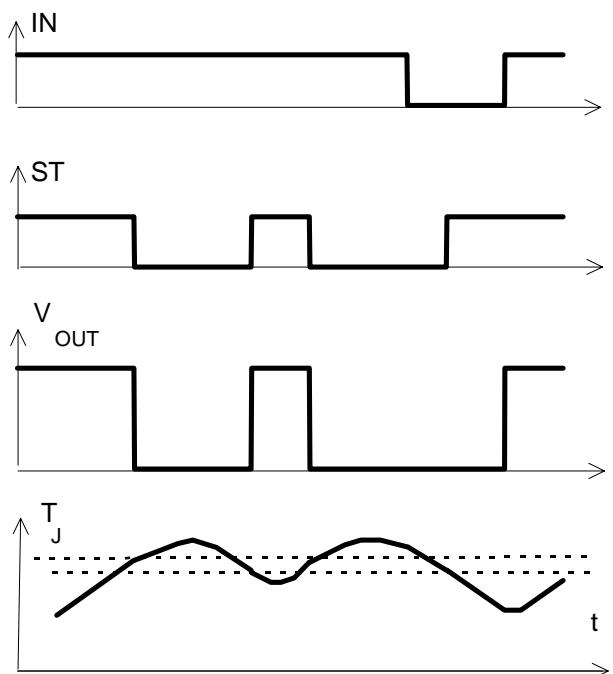
Heating up may require several milliseconds,  
 $V_{bb} - V_{OUT} < 8.3$  V typ.

**Figure 3c:** Short circuit while on:

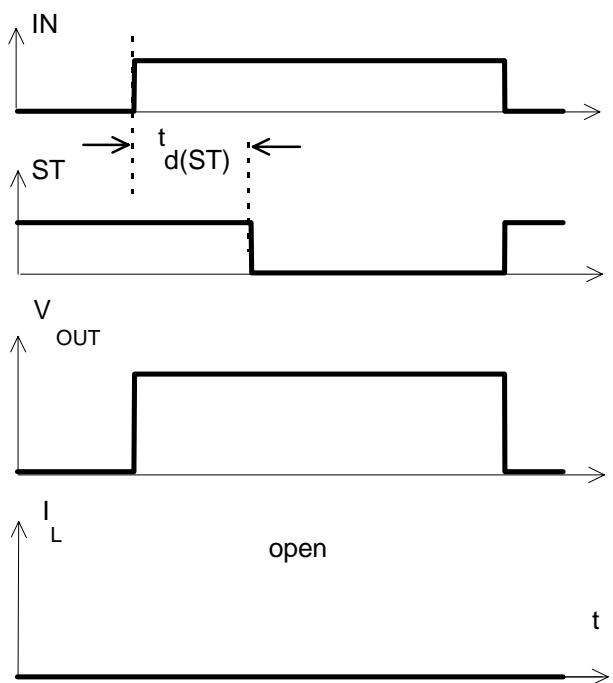


\*\*\*) current peak approx. 20  $\mu$ s

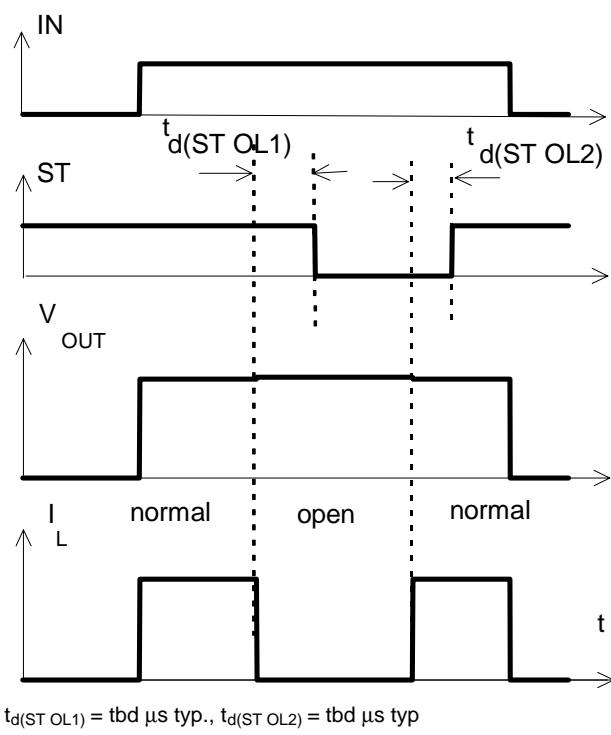
**Figure 4a:** Overtemperature:  
 Reset if  $T_j < T_{jt}$



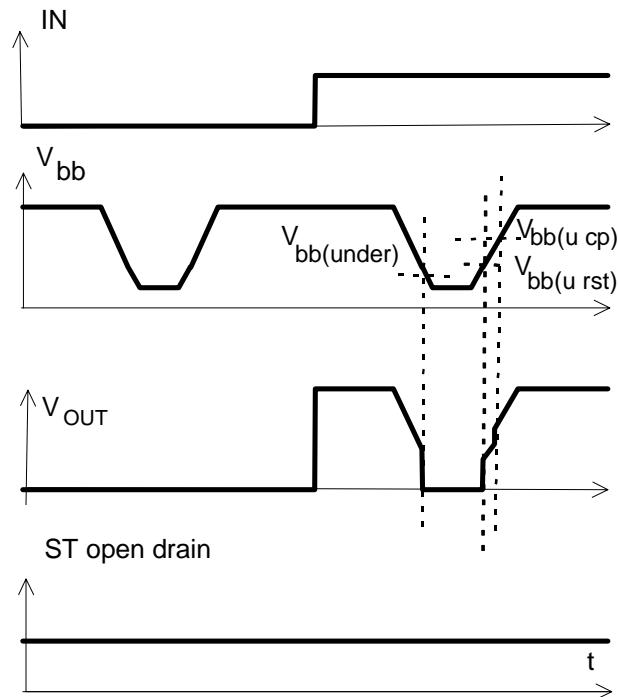
**Figure 5a:** Open load: detection in ON-state, turn on/off to open load



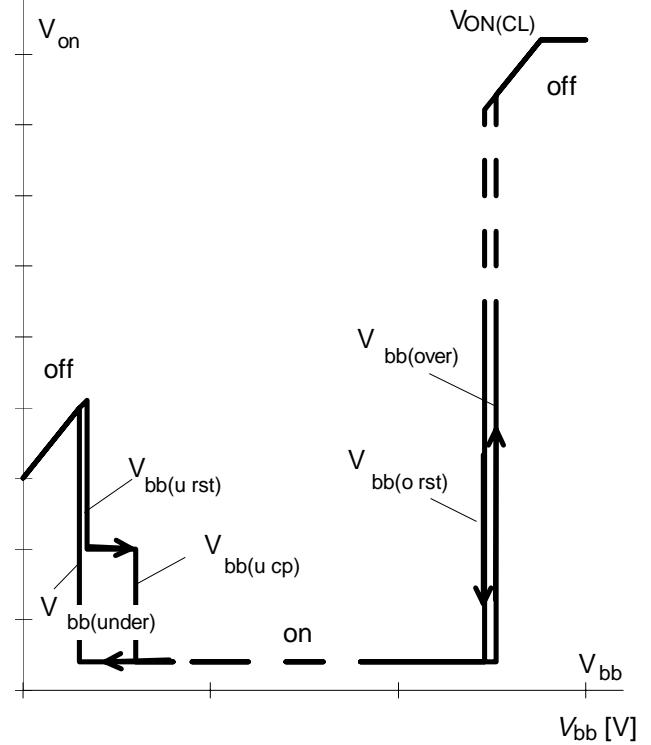
**Figure 5b:** Open load: detection in ON-state, open load occurs in on-state



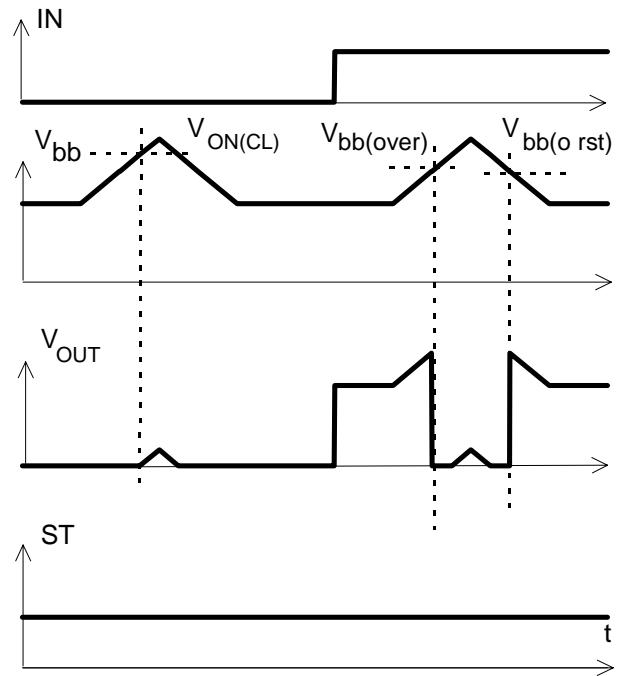
**Figure 6a:** Undervoltage:



**Figure 6b:** Undervoltage restart of charge pump  
V<sub>ON</sub> [V]



**Figure 7a:** Overvoltage:



### Package and Ordering Code

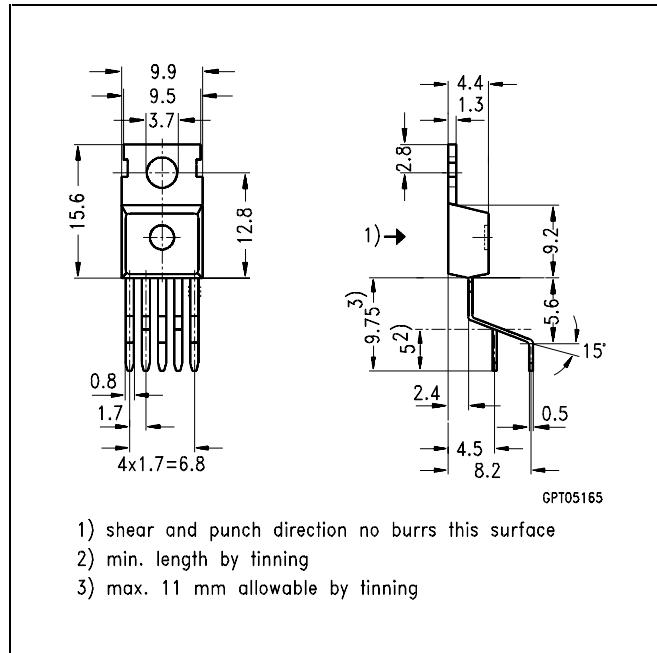
All dimensions in mm

#### Standard TO-220AB/5

Ordering code

BTS 442 E2

Q67060-S6206-A2

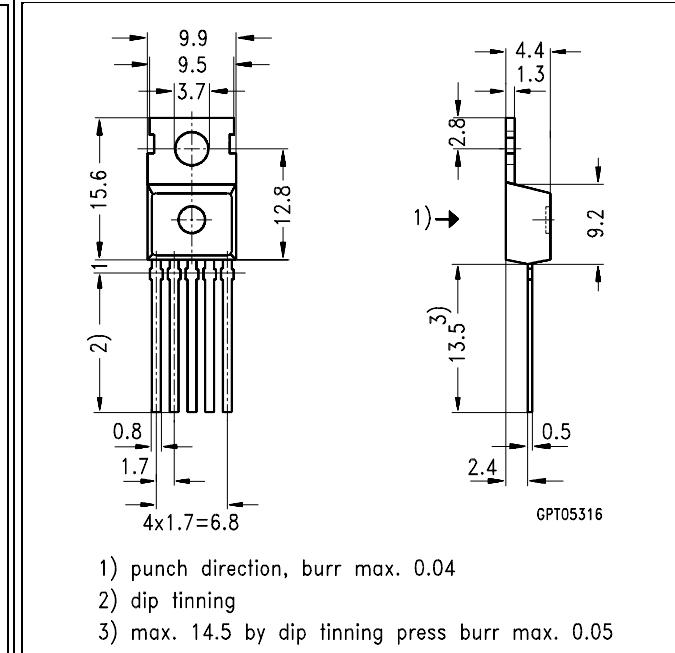


#### TO-220AB/5, Option E3043

Ordering code

BTS 442 E2 E3043

Q67060-S6206-A3

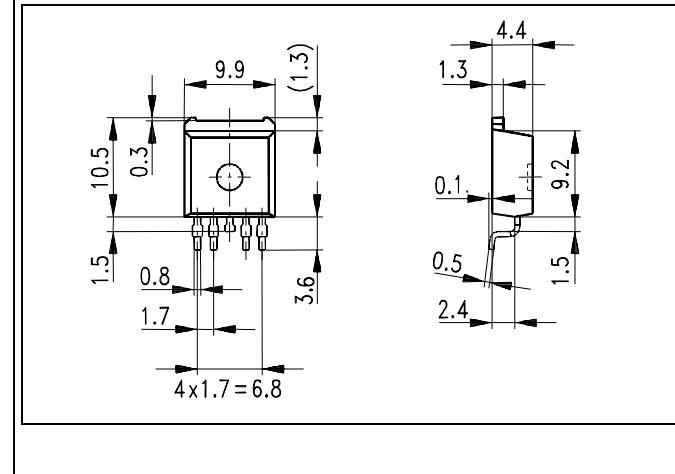


#### SMD TO-220AB/5, Opt. E3062

Ordering code

BTS442E2 E3062A

T&R: Q67060-S6206-A4



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